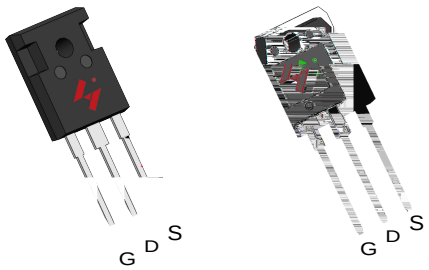
N-Channel Enhancement Mode MOSFET

Features

- 80V/360A
  $R_{DS(ON)}$= 1.5 mΩ (typ.) @ V_{GS}=10V
- 100% avalanche tested
- Reliable and Rugged
- Lead Free and Green Devices Available
  (RoHS Compliant)

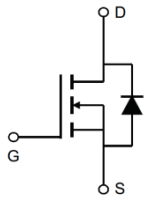
Pin Description



A

Applications

- Switching application
- Power Management for Inverter Systems.



N Channel MOSFET

Ordering and Marking Information

W HY5608 YYXXXJWW G A HY5608 YYXXXJWW G	Package Code W : TO-247A-3L A : TO-3P-3L Date Code Assembly Material YYXXX WW G : Lead Free Device

Note: HUAYI lead -free products contain molding compounds/die attach materials and 100% matte tin plate Termination finish;which are fully compliant with RoHS. HUAYI lead -free products meet or exceed the lead-Free requirements of IPC/JEDEC J-STD-020 for MSL classification at lead-free peak reflow temperature. HUAYI defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr-oduct and/or to this document at any time without notice.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
		1290**	
		2829***	
		HY5608	
		80	
		1.5	

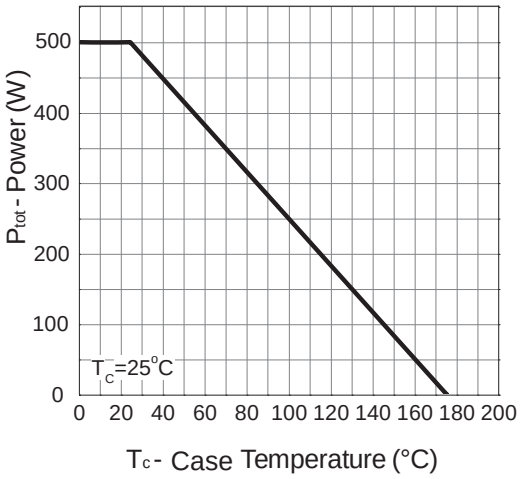
Electrical Characteristics (Cont.) (T_C = 25°C Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	HY5608			Unit
			Min.	Typ.	Max.	
Dynamic Characteristics						
R_G	Gate Resistance	V_{GS}=0V,V_{DS}=0V,F=1MHz	-	0.5	-	Ω
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=25V, Frequency=1.0MHz	-	14715	-	pF
C_{oss}	Output Capacitance		-	1714	-	
C_{rss}	Reverse Transfer Capacitance		-	853	-	
$t_{d(ON)}$	Turn-on Delay Time	V_{DD}=40V, R_G=6 Ω, I_{DS} =180A, V_{GS}=10V,	-	60	-	ns
T_r	Turn-on Rise Time		-	47	-	
$t_{d(OFF)}$	Turn-off Delay Time		-	100	-	
T_f	Turn-off Fall Time		-	88	-	
Gate Charge Characteristics						
Q_g	Total Gate Charge	V_{DS}=64V, V_{GS}=10V, I_{DS}=180A	-	365	-	nC
Q_{gs}	Gate-Source Charge		-	55	-	
Q_{gd}	Gate-Drain Charge		-	141	-	

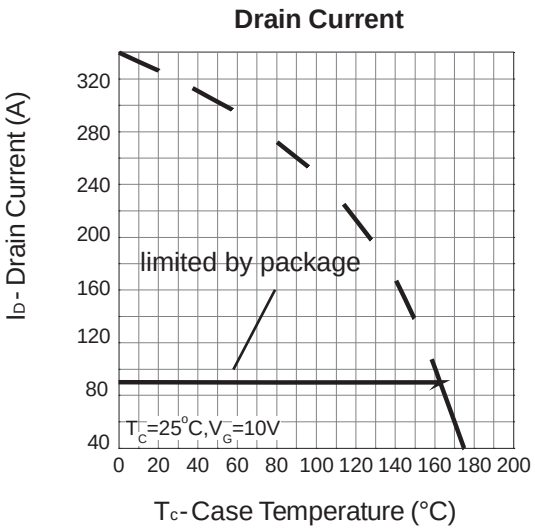
Note * : Pulse test ; pulse width ≤300μs, duty cycle≤2%.

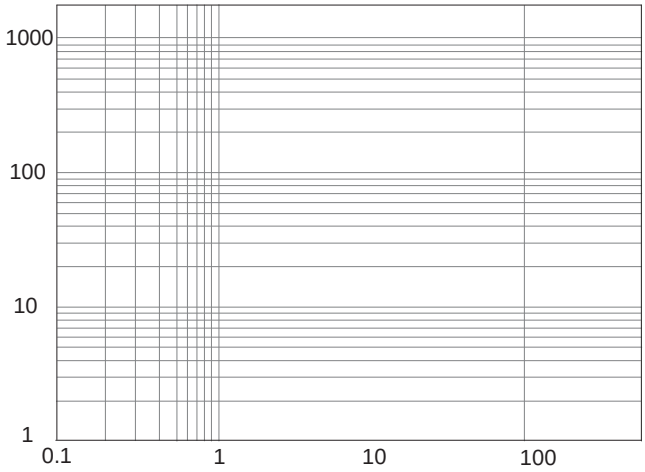
Typical Operating Characteristics

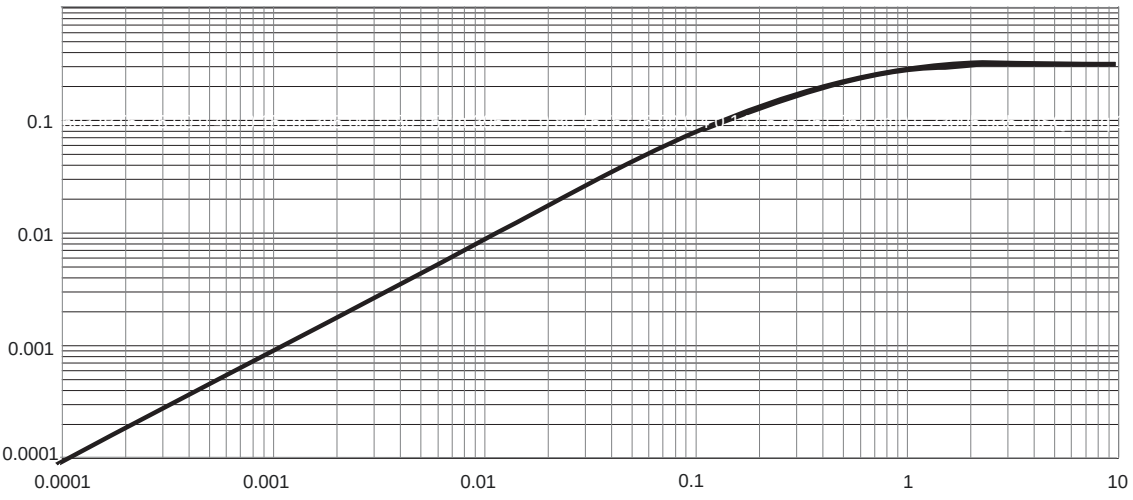
Power Dissipation



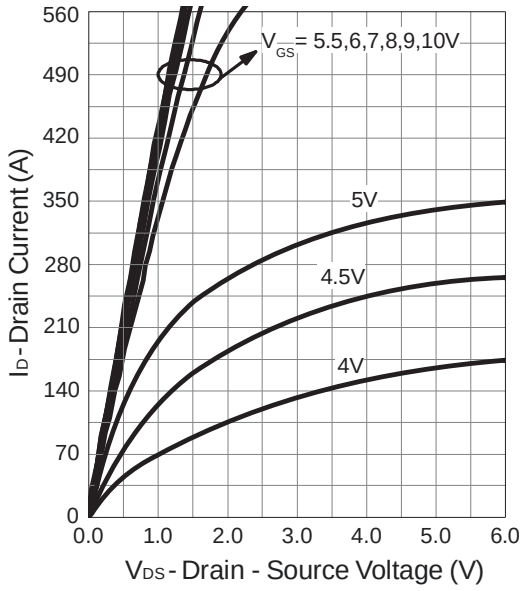
Drain Current

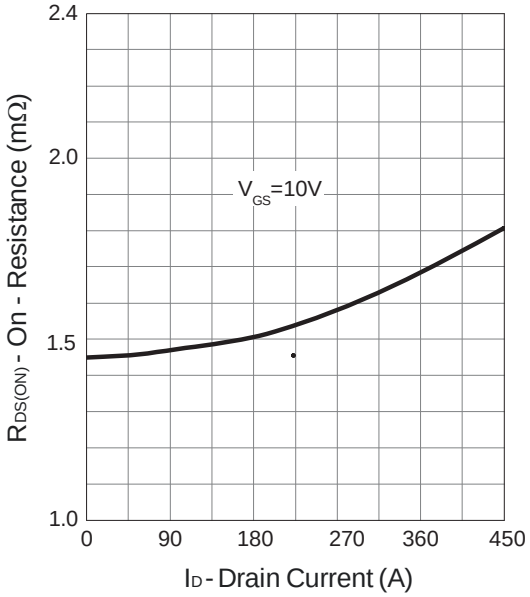


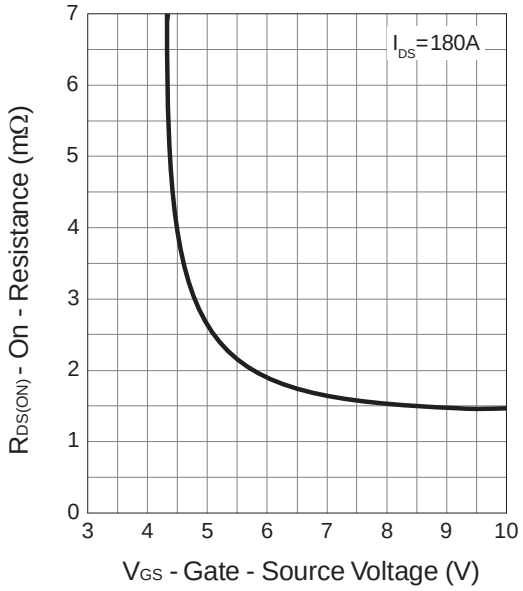


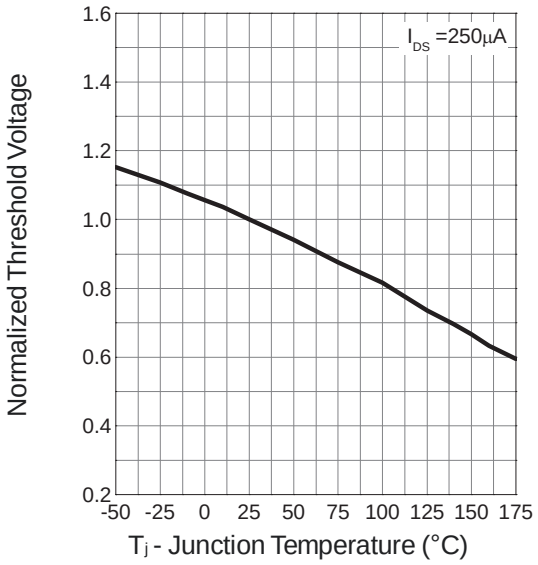


Typical Operating Characteristics (Cont.)

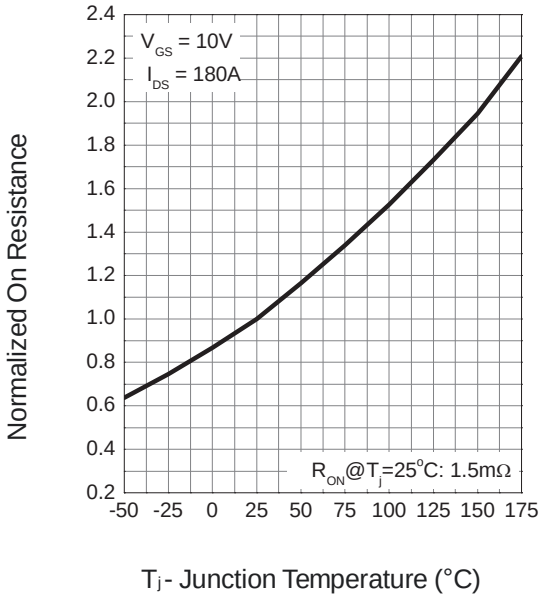


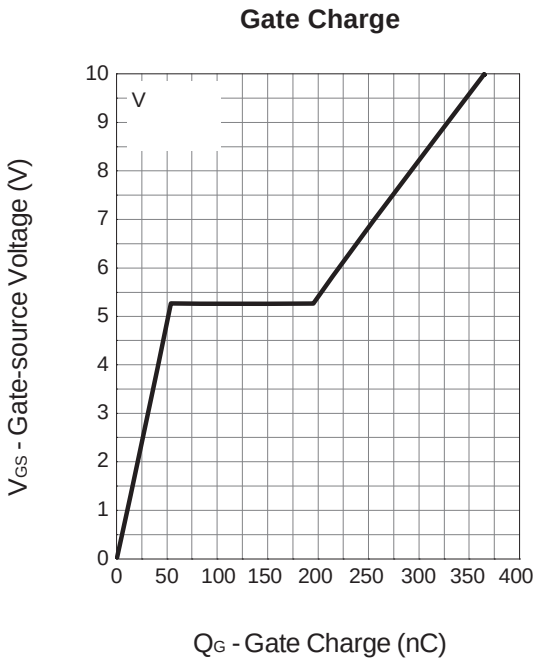




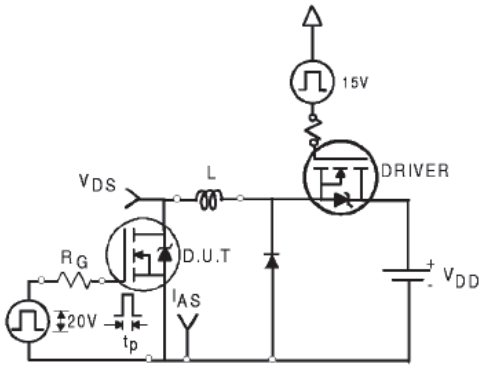


Typical Operating Characteristics (Cont.)

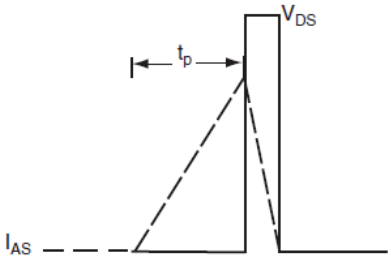




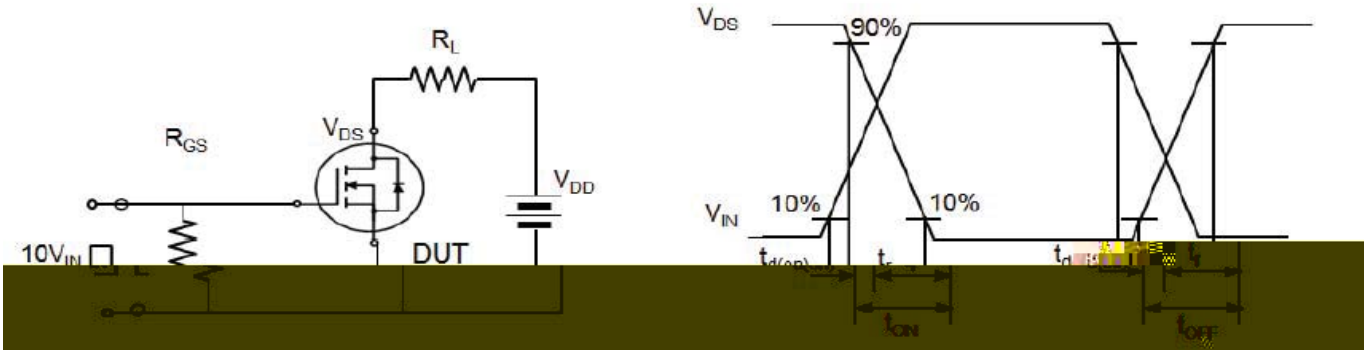
Avalanche Test Circuit



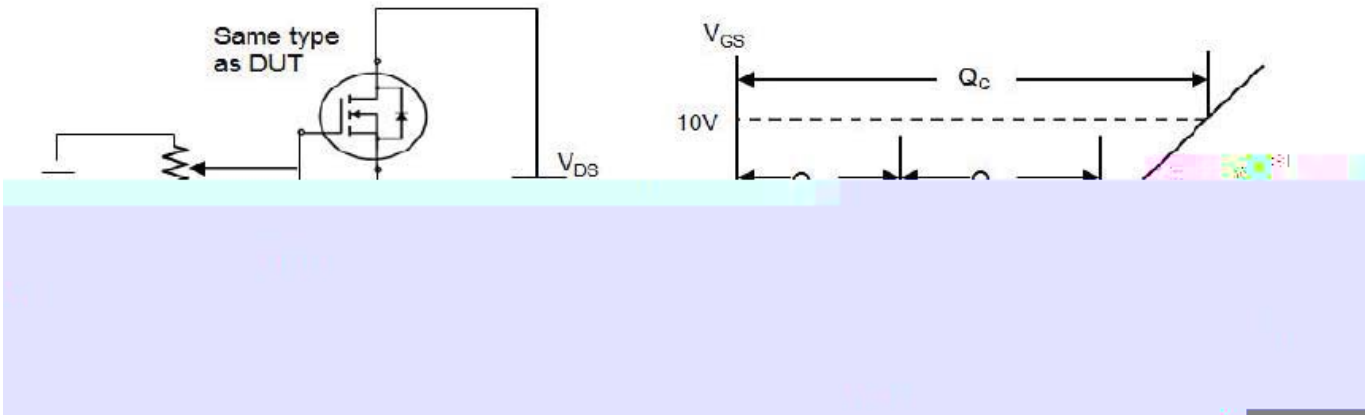
$$E_{AS} = \frac{1}{2} L I_{AS}^2$$



Switching Time Test Circuit



Gate Charge Test Circuit

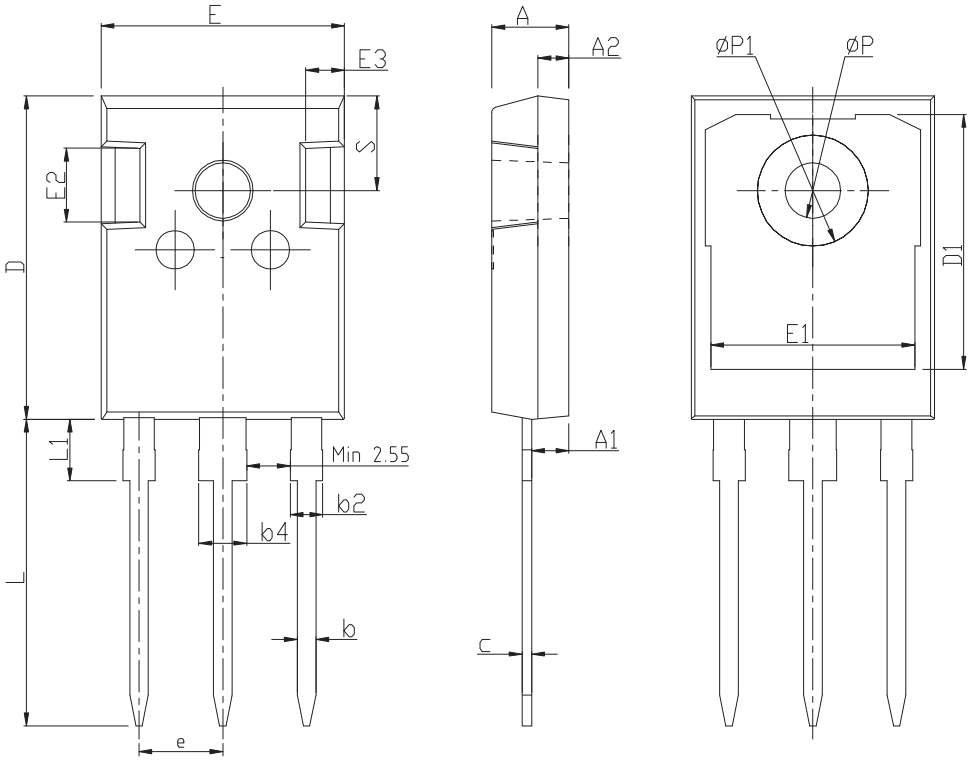


Device Per Unit

Package Type	Unit	Quantity
TO-247A-3L	Tube	30

Package Information

TO-247A-3L

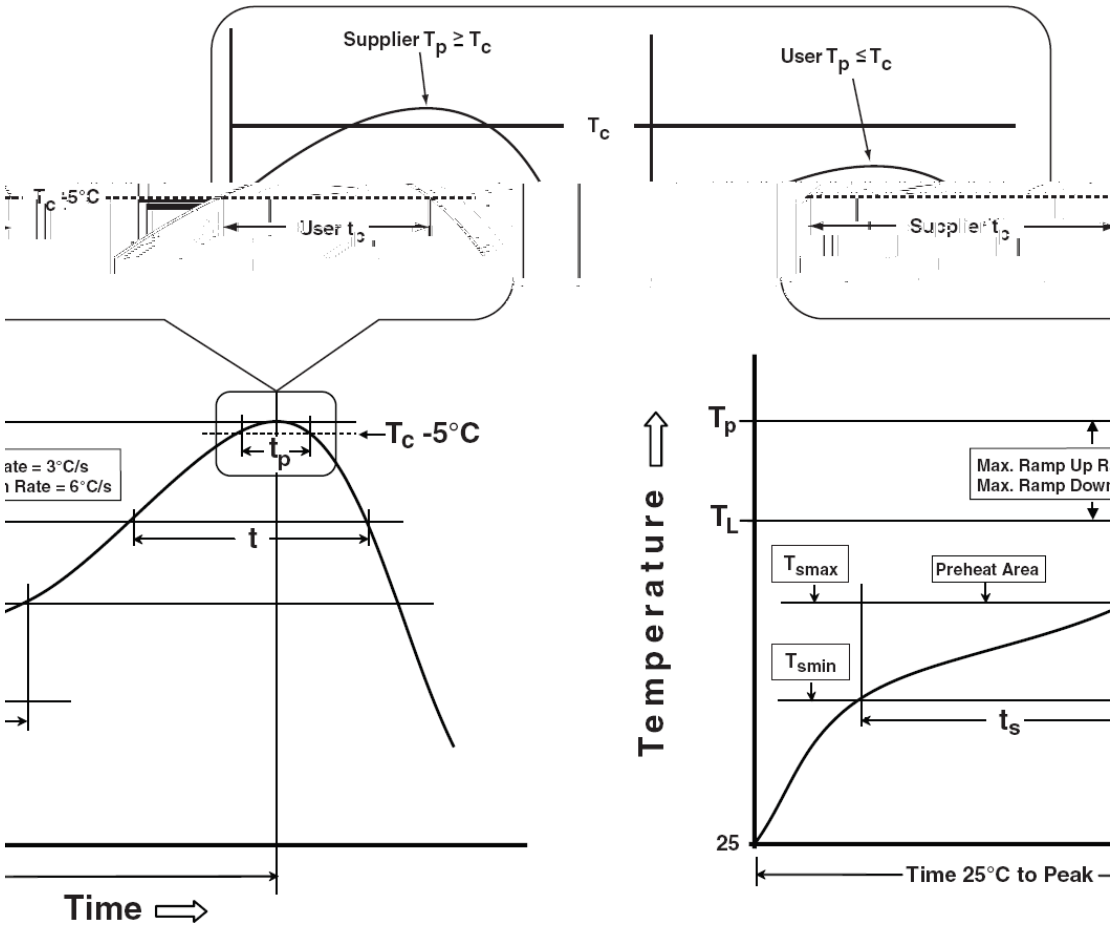


COMMON DIMEN

3P

3P

Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak Temperature min (T_{smin}) Temperature max (T_{smax}) Time (T_{smin} to T_{smax}) (t_s)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-120 seconds
Average ramp-up rate (T_{smax} to T_P)	3 °C/second max.	3°C/second max.
Liquidous temperature (T_L) Time at liquidous (t_L)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body Temperature (T_p)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_P)** within 5°C of the specified classification temperature (T_c)	20** seconds	30** seconds
Average ramp-down rate (T_p to T_{smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_p) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm^3 <350	Volume mm^3 ≥350	3463 71Sn64 ref 529 652 57

Table 2. Pb-free Process – Classification Temperatures (Tc)

Package Thickness	Volume mm^3 <350	Volume mm^3 350-2000	Volume mm^3 >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C